

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6020I uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

Genera Features

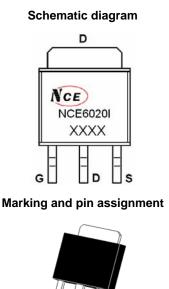
- V_{DS} =60V,I_D =20A
 R_{DS(ON)} <44mΩ @ V_{GS}=10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



(2) D

(3) s

(1) GO

TO-251 top view

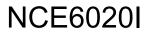
Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE6020I	NCE6020I	TO-251	-	-	-

Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	60	V	
Gate-Source Voltage	V _{GS}	±20	V	
Drain Current-Continuous	Ι _D	20	А	
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	14	А	
Pulsed Drain Current	I _{DM}	45	А	
Maximum Power Dissipation	PD	30	W	
Derating factor		0.2	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	72	mJ	
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C	





Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	5	°C/W
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Electrical Characteristics (T_C=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·		•	•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA 60		-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·		•	•		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.2	2.0	2.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =10A	-	37	44	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =4.5A	11	-	-	S
Dynamic Characteristics (Note4)	·		•	•		
Input Capacitance	C _{lss}		-	500	-	PF
Output Capacitance	C _{oss}	V _{DS} =30V,V _{GS} =0V,	-	60	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	25	-	PF
Switching Characteristics (Note 4)			•	•		
Turn-on Delay Time	t _{d(on)}		-	5	-	nS
Turn-on Rise Time	tr	V _{DD} =30V,I _D =2A,R _L =6.7Ω	-	2.6	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =3 Ω	-	16.1	-	nS
Turn-Off Fall Time	t _f		-	2.3	-	nS
Total Gate Charge	Qg	V/ 00)// 4 5A	-	14		nC
Gate-Source Charge	Q _{gs}	V_{DS} =30V,I _D =4.5A,	-	2.9		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	5.2		nC
Drain-Source Diode Characteristics			•	•		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	20	А
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =20A	-	35	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	53	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				y LS+LD)

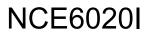
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition:Tj=25 $^{\circ}$ C,V_{DD}=30V,V_G=10V,L=0.5mH,Rg=25 Ω

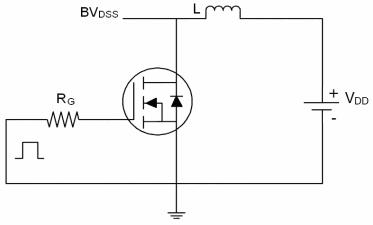


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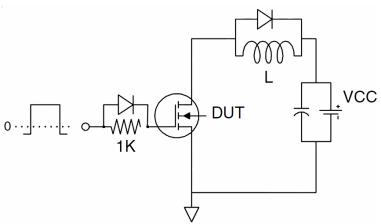
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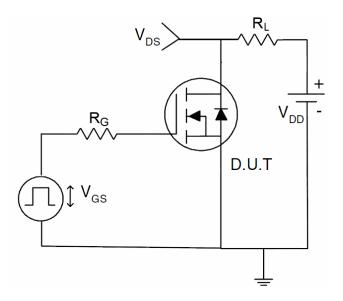
Test Circuit 1) E_{AS} test Circuit



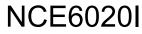
2) Gate charge test Circuit



3) Switch Time Test Circuit







V_{GS} = 10V

10

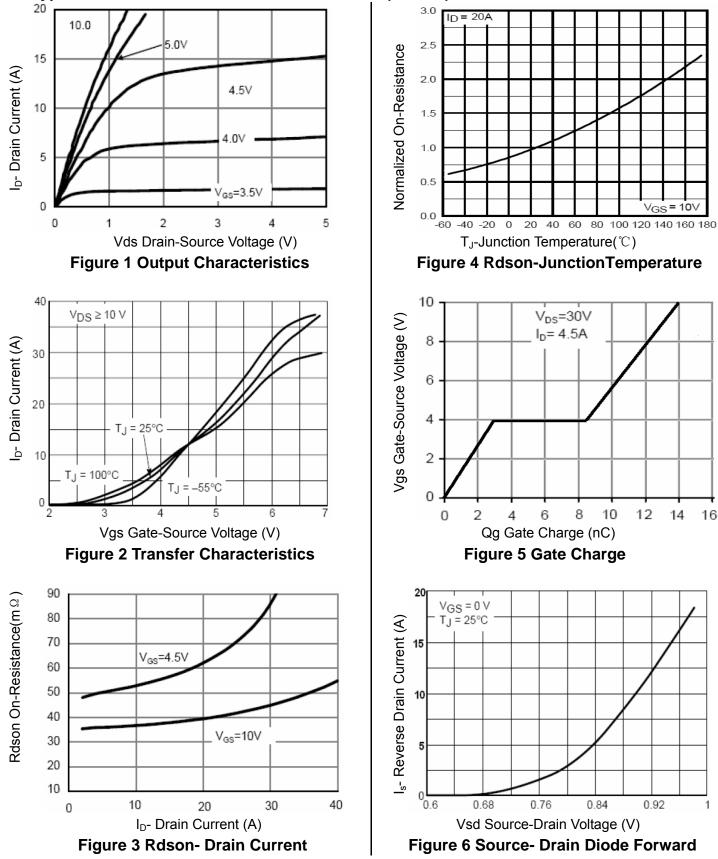
12

0.92

14

16



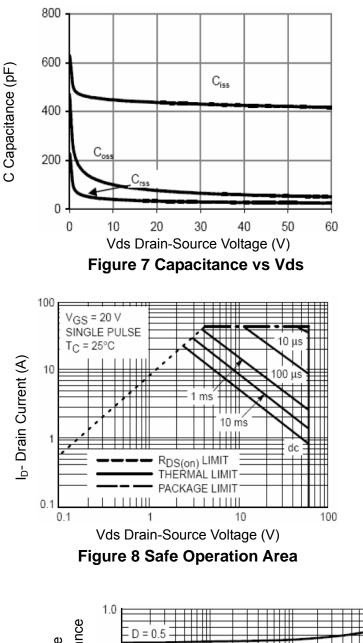




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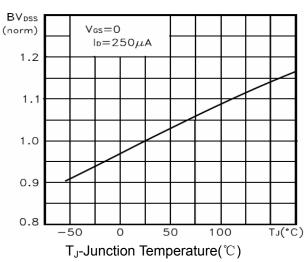


Figure 9 BV_{DSS} vs Junction Temperature

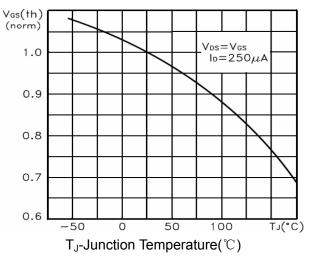
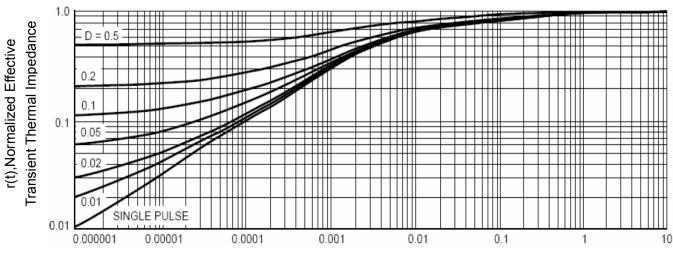


Figure 10 $V_{GS(th)}$ vs Junction Temperature

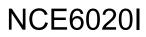


Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance

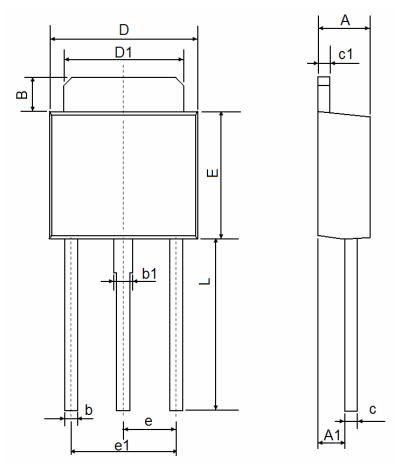


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TO-251 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	1.050	1.350	0.042	0.054	
В	1.350	1.650	0.053	0.065	
b	0.500	0.700	0.020	0.028	
b1	0.700	0.900	0.028	0.035	
С	0.430	0.580	0.017	0.023	
c1	0.430	0.580	0.017	0.023	
D	6.350	6.650	0.250	0.262	
D1	5.200	5.400	0.205	0.213	
E	5.400	5.700	0.213	0.224	
е	2.300 TYP		0.092	1 TYP	
e1	4.500	4.700	0.177	0.185	
L	7.500	7.900	0.295	0.311	







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